





P-CHANNEL ENHANCEMENT MODE MOSFET

Features

- Low On-Resistance
 - $39m\Omega @ V_{GS} = -4.5V$
 - $52m\Omega$ @ $V_{GS} = -2.5V$
 - $65m\Omega @ V_{GS} = -1.8V$
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 1)
- ESD Protected Up To 3kV
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

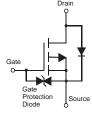
- Case: SOT-23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Terminals Connections: See Diagram Below
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.008 grams (approximate)

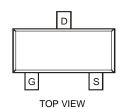




TOP VIEW







Internal Schematic

Maximum Ratings @T_A = 25°C unless otherwise specified

Characte	eristic		Symbol	Value	Units
Drain-Source Voltage			V_{DSS}	-20	V
Gate-Source Voltage			V _{GSS}	±8	V
Continuous Drain Current (Note 3)	T _A = 25°C T _A = 70°C	I _D	-4.0 -3.5	А	
Pulsed Drain Current (Note 4)		I _{DM}	-30	Α	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3)	P_{D}	0.9	W
Thermal Resistance, Junction to Ambient @T _A = 25°C	R _{0JA}	139	°C/W
Operating and Storage Temperature Range	$T_{J_1}T_{STG}$	-55 to +150	°C

Notes:

- 1. No purposefully added lead.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 3. Device mounted on FR-4 PCB with 2oz. Copper and test pulse width t ≤ 10s.
- 4. Repetitive rating, pulse width limited by junction temperature.

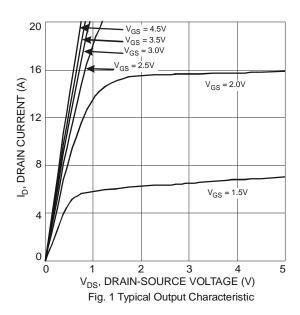


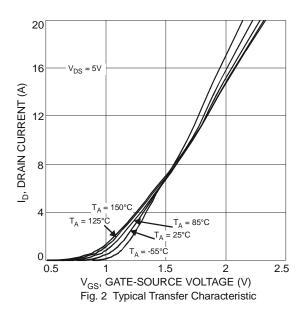
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 5)							
Drain-Source Breakdown Voltage		BV _{DSS}	-20			V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	$T_J = 25^{\circ}C$	I _{DSS}	_		-1.0	μΑ	$V_{DS} = -20V$, $V_{GS} = 0V$
Gate-Source Leakage		I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage		V _{GS(th)}	-0.3	-0.55	-1.0	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$
				31	39		$V_{GS} = -4.5V$, $I_{D} = -4.0A$
Static Drain-Source On-Resistance		R _{DS} (ON)	_	40	52	mΩ	$V_{GS} = -2.5V$, $I_{D} = -3.5A$
				51	65		$V_{GS} = -1.8V, I_D = -2.0A$
Forward Transfer Admittance		Y _{fs}	_	3		S	$V_{DS} = -5V, I_{D} = -4A$
DYNAMIC CHARACTERISTICS							_
Input Capacitance		C _{iss}	_	294		рF	101/11/101/
Output Capacitance	Coss	_	104	_	pF	$V_{DS} = -10V, V_{GS} = 0V$ - f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	25		pF	T = 1.0WH IZ	
Gate Resistnace		R_g	_	250		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
SWITCHING CHARACTERISTICS							_
Total Gate Charge		Q_{g}	_	9.1	_	nC	
Gate-Source Charge Gate-Drain Charge		Q_{gs}	_	1.5	_	nC	$V_{GS} = -4.5V$, $V_{DS} = -10V$, $I_{D} = -4A$
		Q_{gd}	_	1.7		nC	
Turn-On Delay Time		t _{D(on)}	_	71	_	ns	
Turn-On Rise Time	t _r	_	117	_	ns	$V_{DS} = -10V, V_{GS} = -4.5V,$	
Turn-Off Delay Time	t _{D(off)}	_	795		ns	$R_D = 2.5\Omega$, $R_G = 3.0\Omega$, $I_D = -1A$	
Turn-Off Fall Time	t _f	_	393		ns		

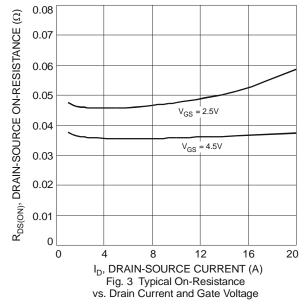
Notes:

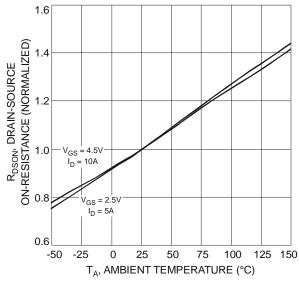
5. Short duration pulse test used to minimize self-heating effect.

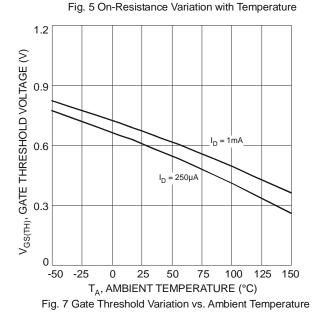


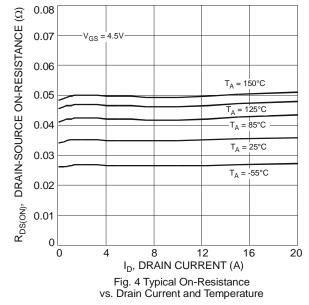


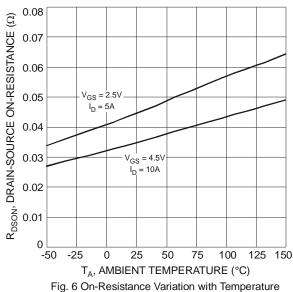


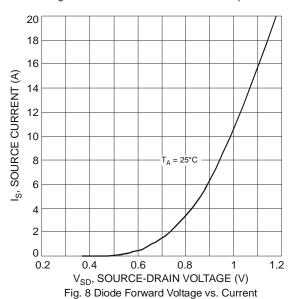














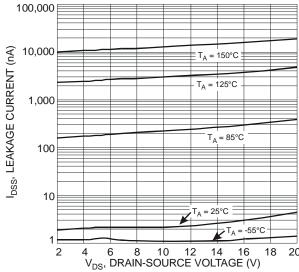
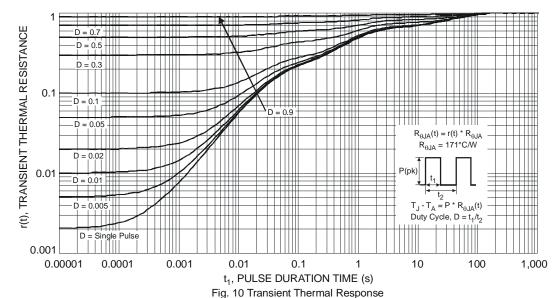


Fig. 9 Typical Leakage Current vs. Drain-Source Voltage

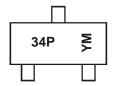


Ordering Information (Note 6)

Part Number	Case	Packaging
DMG3415U-7	SOT-23	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



34P = Product Type Marking Code YM = Date Code Marking

Y = Year (ex: W = 2009)

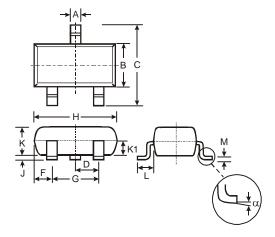
M = Month (ex: 9 = September)

Date Code Key

Year	2009	9	2010		2011	20	12	2013		2014		2015
Code	W		Χ		Υ		Z	Α		В		С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

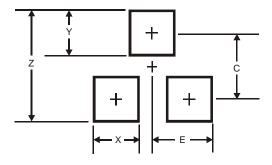


Package Outline Dimensions



	SOT-23						
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
7	0.013	0.10	0.05				
K	0.903	1.10	1.00				
K1	-	-	0.400				
L	0.45	0.61	0.55				
M	0.085	0.18	0.11				
α	0°	8°	-				
All Dimensions in mm							

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
Е	1.35



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